

XDR-S40DBP

SERVICE MANUAL

Ver. 1.0 2013.01

AEP Model
UK Model
Australian Model



SPECIFICATIONS

Frequency range

DAB (Band-III): 174.928 MHz — 239.200 MHz
FM: 87.5 MHz — 108 MHz (0.05 MHz step)

Intermediate frequency

DAB (Band-III): 2.048 MHz
FM: 1.943 MHz

DAB (Band-III) frequency table (MHz)

Channel	Frequency	Channel	Frequency	Channel	Frequency
5A	174.928	8C	199.360	11C	220.352
5B	176.640	8D	201.072	11D	222.064
5C	178.352	9A	202.928	12A	223.936
5D	180.064	9B	204.640	12N	224.096
6A	181.936	9C	206.352	12B	225.648
6B	183.648	9D	208.064	12C	227.360
6C	185.360	10A	209.936	12D	229.072
6D	187.072	10N	210.096	13A	230.784
7A	188.928	10B	211.648	13B	232.496
7B	190.640	10C	213.360	13C	234.208
7C	192.352	10D	215.072	13D	235.776
7D	194.064	11A	216.928	13E	237.488
8A	195.936	11N	217.088	13F	239.200
8B	197.648	11B	218.640		

Speaker: Approx. 6.6 cm dia., 8Ω, monaural

Audio power output: 0.3 W

Output: ◡ (headphones) jack (ø 3.5 mm, stereo mini jack)

Power requirements: 6 V DC, four LR6 (size AA) alkaline batteries

External power source: DC IN 6V

Battery life (JEITA)*:

Approx. 13 hours for DAB, 10 hours for FM (Using Sony (LR6SG) alkaline batteries)

Approx. 11 hours for DAB, 9 hours for FM (Using Sony (NH-AA) Ni-MH batteries)

Dimensions: Approx. 180 mm x 95 mm x 36 mm (W/H/D) excl. projecting parts and controls

Mass: Approx. 445 g incl. batteries

Supplied accessories: AC adaptor (1)

* When listening through the speaker. Measured by JEITA (Japan Electronics and Information Technology Industries Association) standards. The actual battery life may vary depending on usage and circumstances.

Design and specifications are subject to change without notice.

- Operate the unit only on the power sources specified in "Specifications." For battery operation, use four LR6 (size AA) alkaline batteries. For AC operation, use only the supplied AC adaptor. Do not use any other type of AC adaptor.
- Failure to use the supplied AC adaptor may cause the unit to malfunction, as the polarity of the plugs of other manufacturers may be different.
- When operating the unit on batteries, it is recommended that you remove the AC adaptor from the wall outlet and the DC IN 6 V jack. Disconnect the plug of the external power source before operating the unit.



NOTES ON CHIP COMPONENT REPLACEMENT

- Never reuse a disconnected chip component.
- Notice that the minus side of a tantalum capacitor may be damaged by heat.

SAFETY-RELATED COMPONENT WARNING!

COMPONENTS IDENTIFIED BY MARK \triangle OR DOTTED LINE WITH MARK \triangle ON THE SCHEMATIC DIAGRAMS AND IN THE PARTS LIST ARE CRITICAL TO SAFE OPERATION. REPLACE THESE COMPONENTS WITH SONY PARTS WHOSE PART NUMBERS APPEAR AS SHOWN IN THIS MANUAL OR IN SUPPLEMENTS PUBLISHED BY SONY.

DIGITAL RADIO DAB/FM

9-893-659-01

2013A33-1

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Sony Corporation

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SONY®

SECTION 1 SERVICING NOTES

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UNLEADED SOLDER

Boards requiring use of unleaded solder are printed with the lead-free mark (LF) indicating the solder contains no lead.

(Caution: Some printed circuit boards may not come printed with the lead free mark due to their particular size)

: LEAD FREE MARK

Unleaded solder has the following characteristics.

- Unleaded solder melts at a temperature about 40 °C higher than ordinary solder.

Ordinary soldering irons can be used but the iron tip has to be applied to the solder joint for a slightly longer time.

Soldering irons using a temperature regulator should be set to about 350 °C.

Caution: The printed pattern (copper foil) may peel away if the heated tip is applied for too long, so be careful!

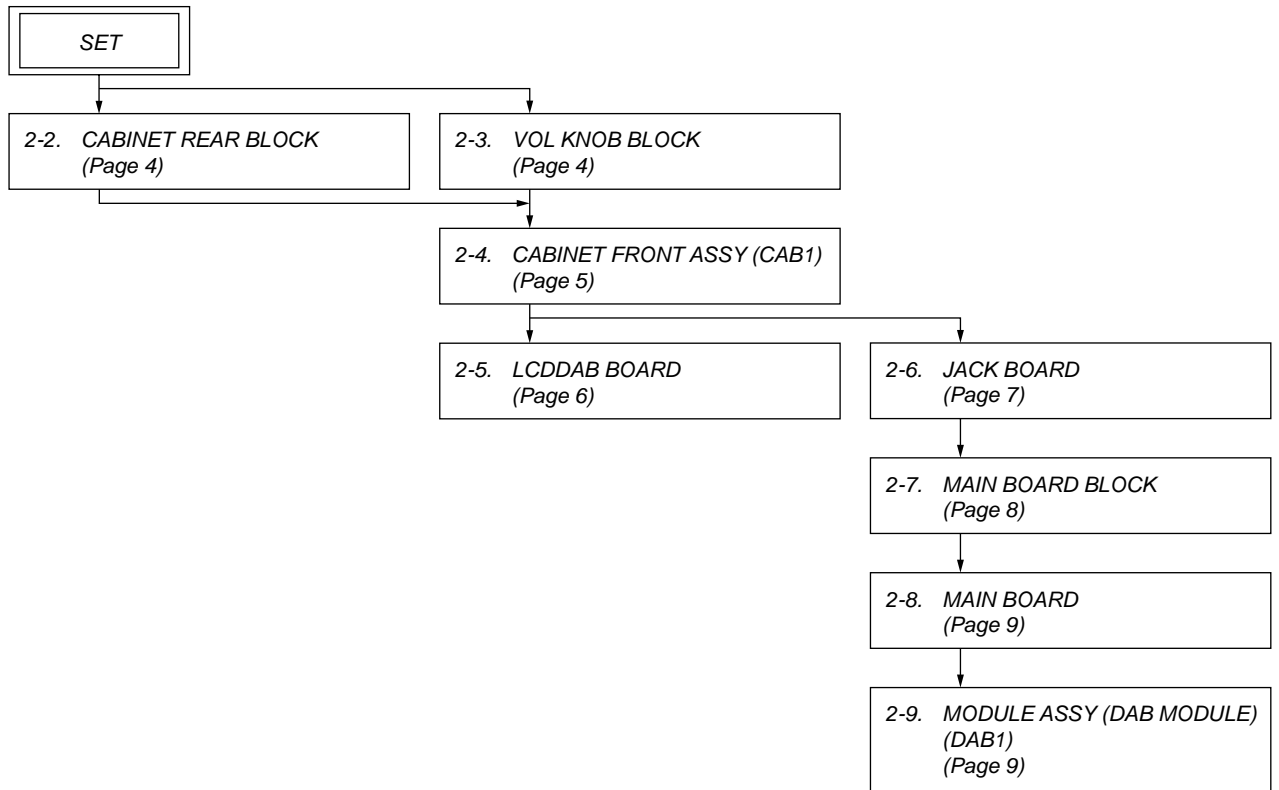
- Strong viscosity
Unleaded solder is more viscous (sticky, less prone to flow) than ordinary solder so use caution not to let solder bridges occur such as on IC pins, etc.
- Usable with ordinary solder
It is best to use only unleaded solder but unleaded solder may also be added to ordinary solder.

Accessories are given in the last of the electrical parts list.

SECTION 2 DISASSEMBLY

- This set can be disassembled in the order shown below.

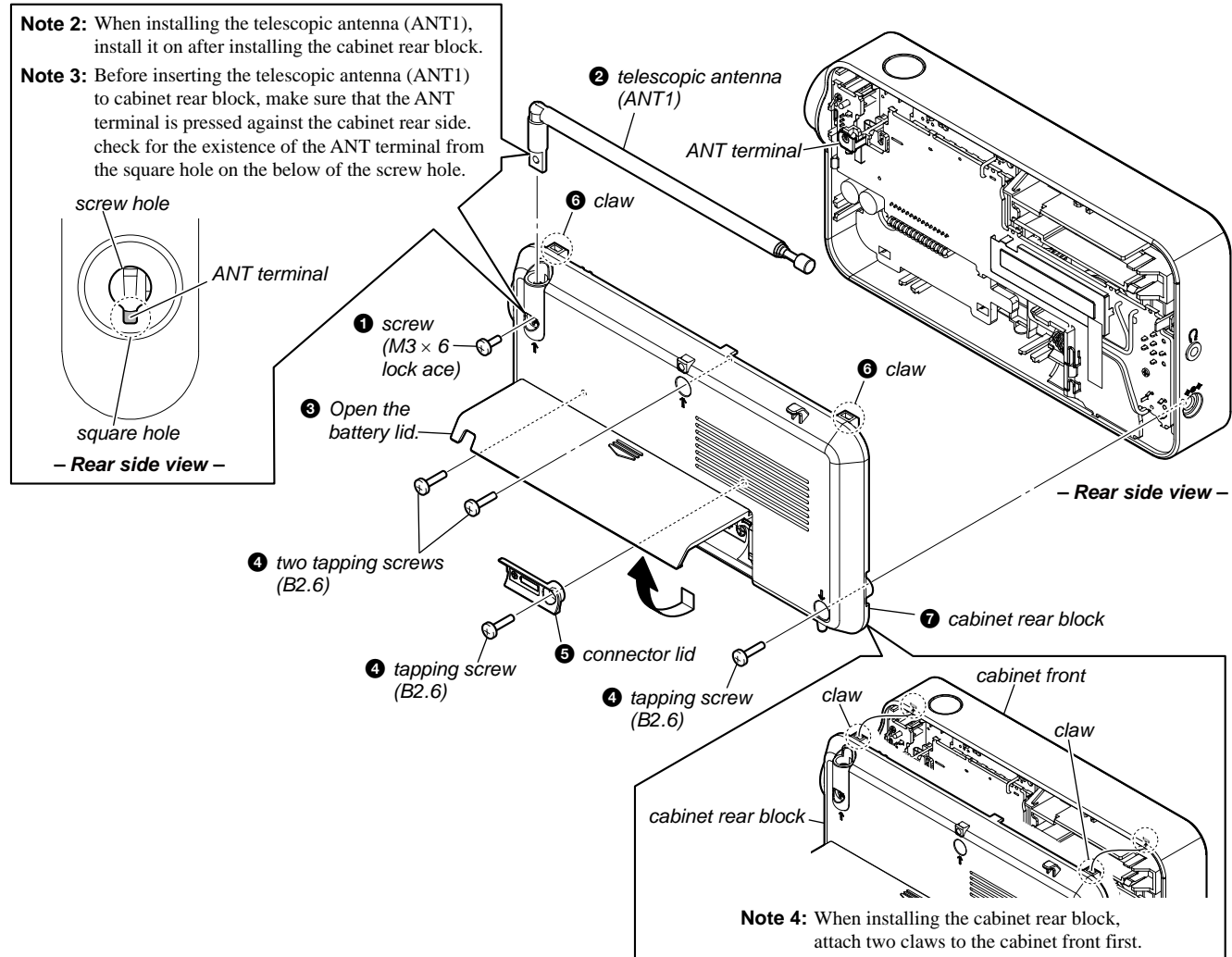
2-1. DISASSEMBLY FLOW



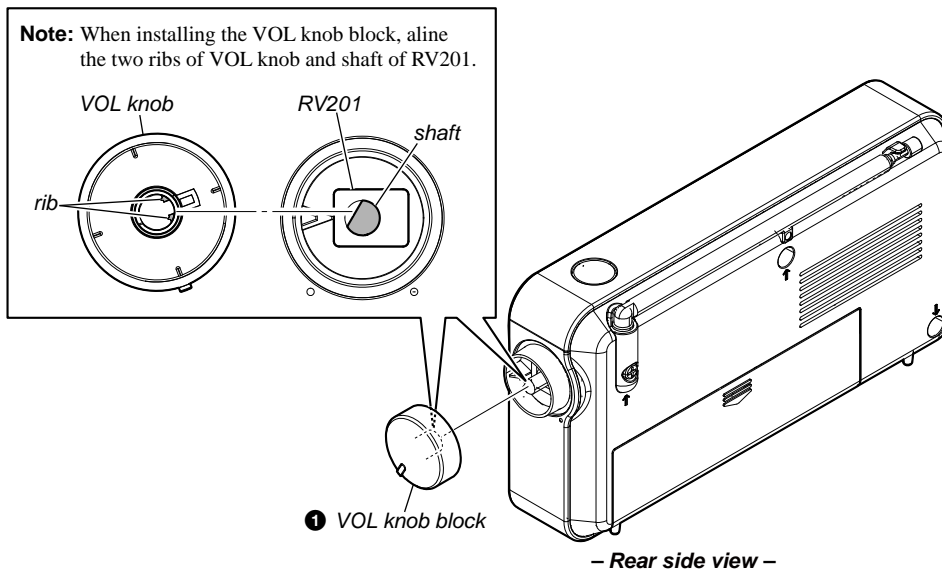
Note: Follow the disassembly procedure in the numerical order given.

2-2. CABINET REAR BLOCK

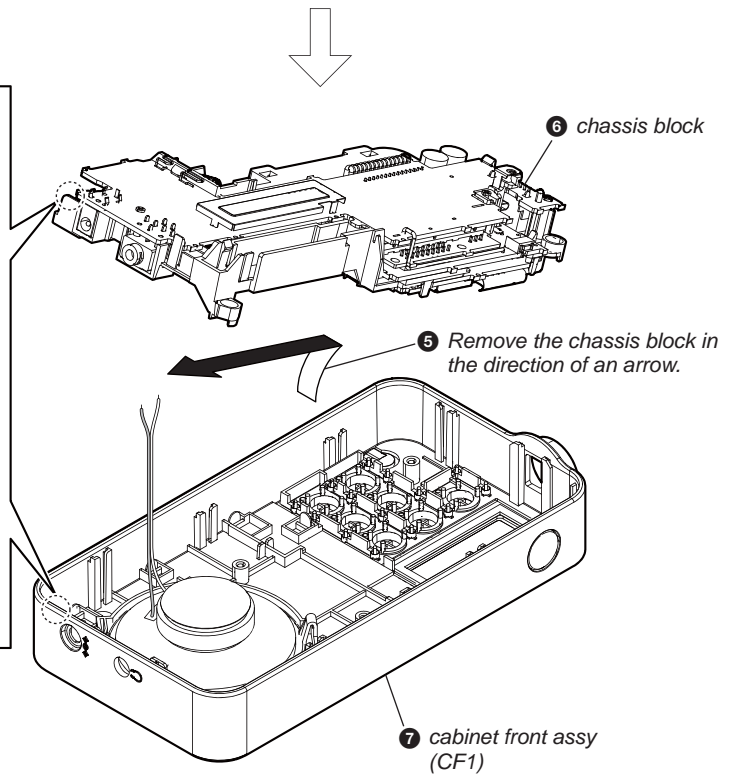
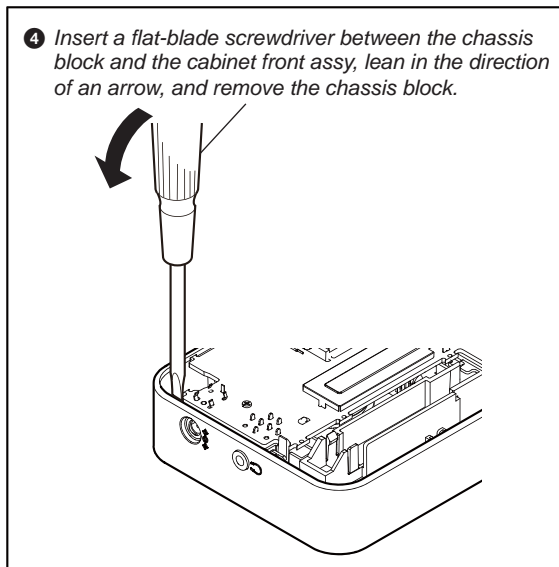
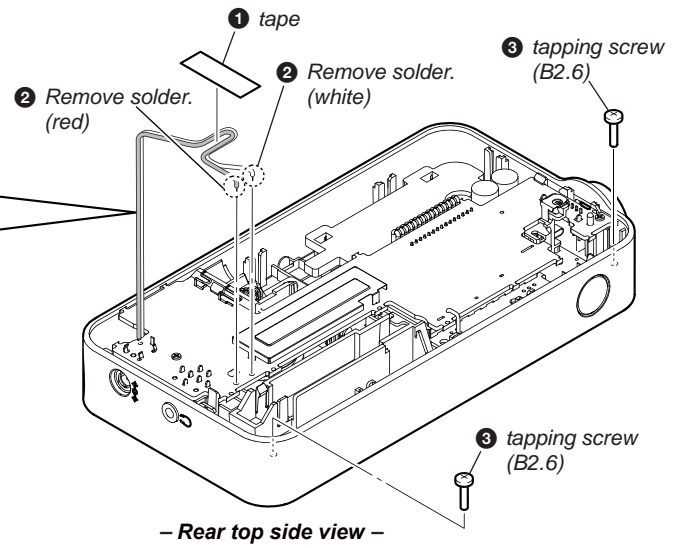
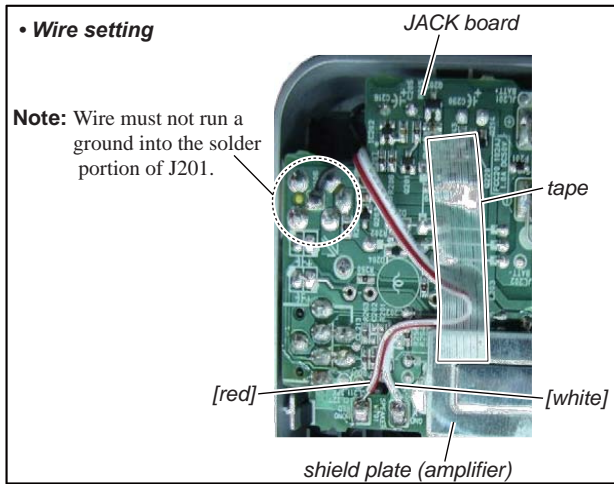
Note 1: Before removing the cabinet rear block, remove the always telescopic antenna (ANT1).



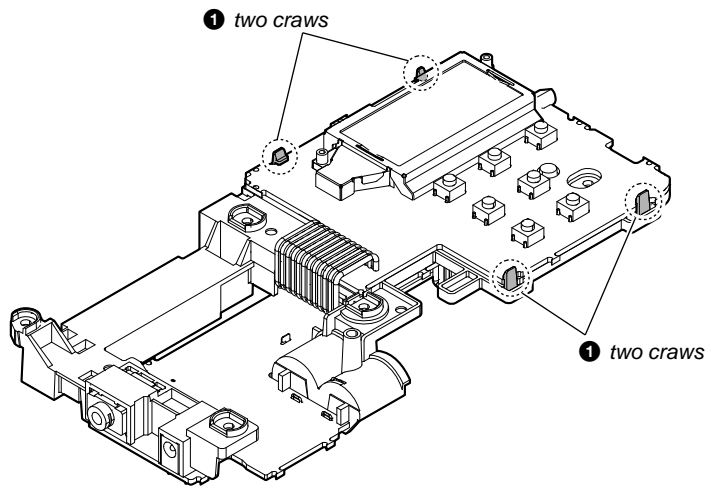
2-3. VOL KNOB BLOCK



2-4. CABINET FRONT ASSY (CAB1)



2-5. LCDDAB BOARD



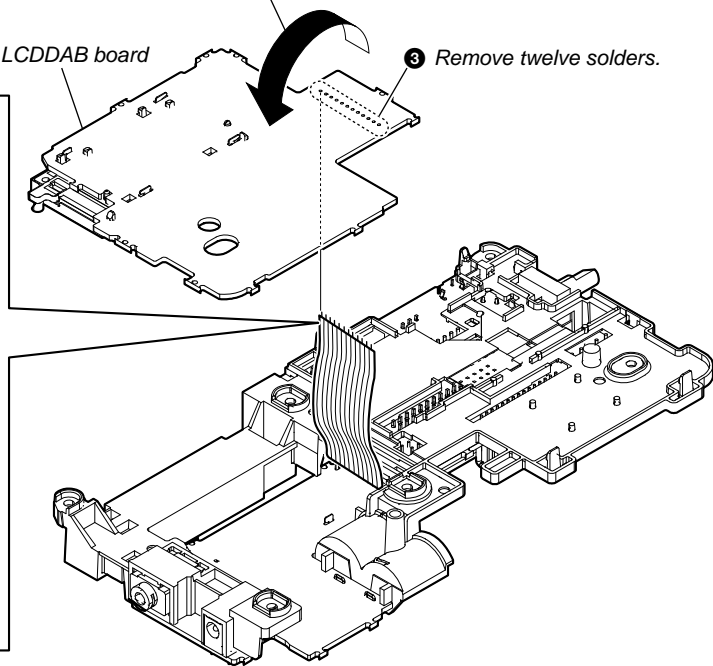
– Front bottom side view –



2 Remove the LCDDAB board in the direction of an arrow.

4 LCDDAB board

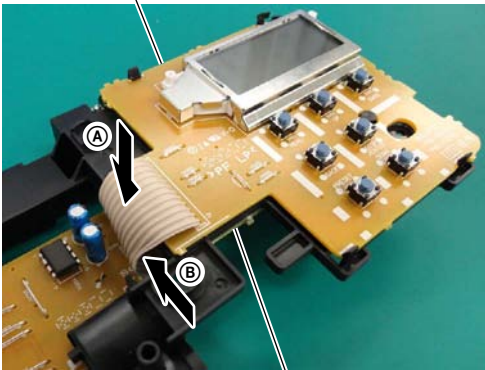
3 Remove twelve solders.



• Wire setting

Note: Arrange a wire in order of arrow (A) and arrow (B).

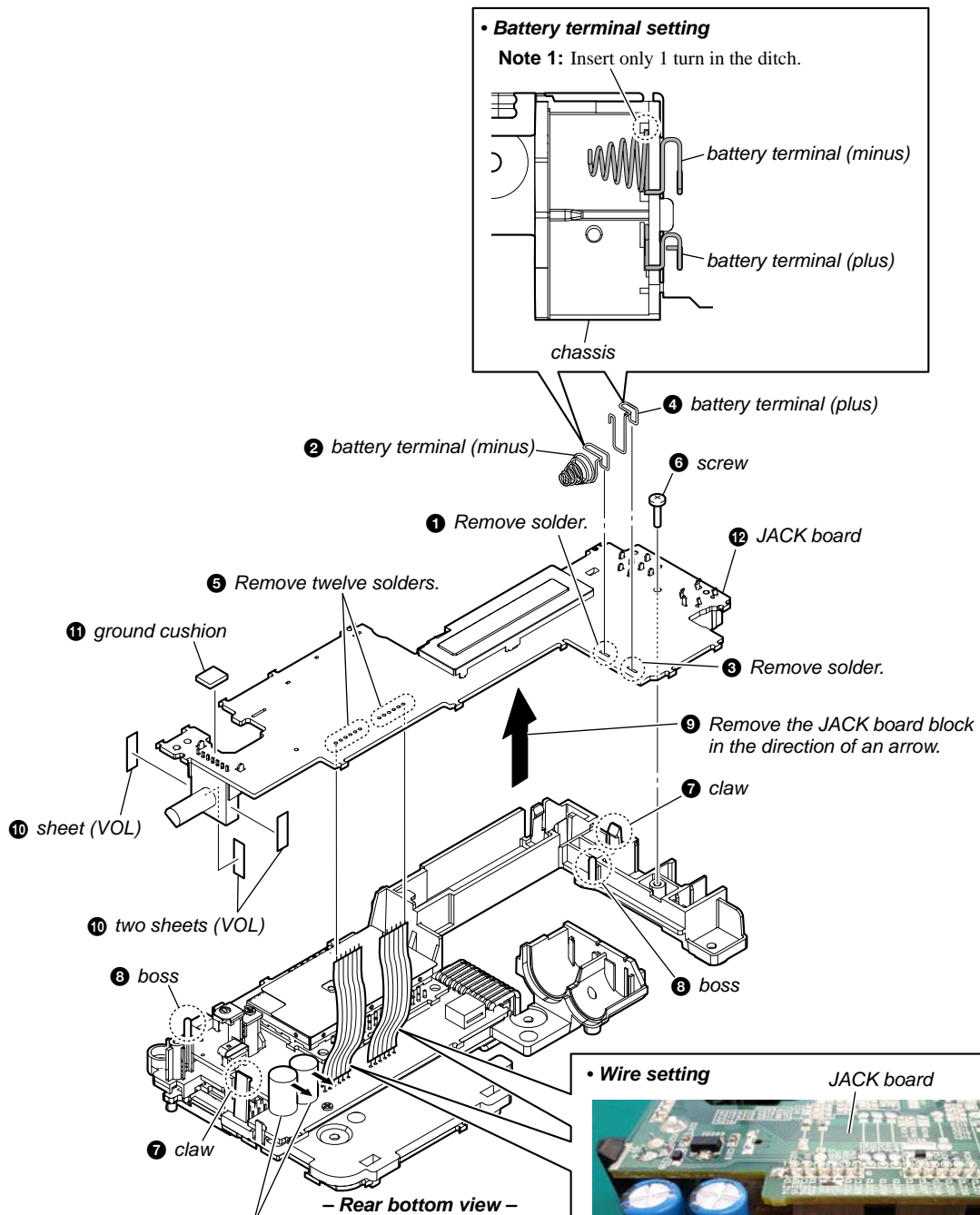
LCDDAB board



MAIN board

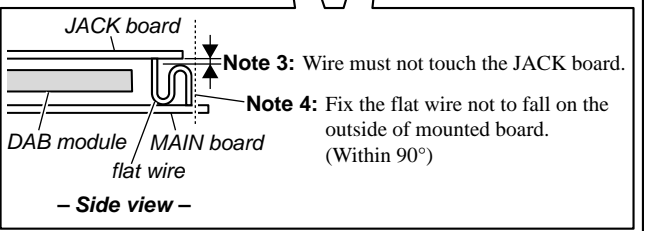
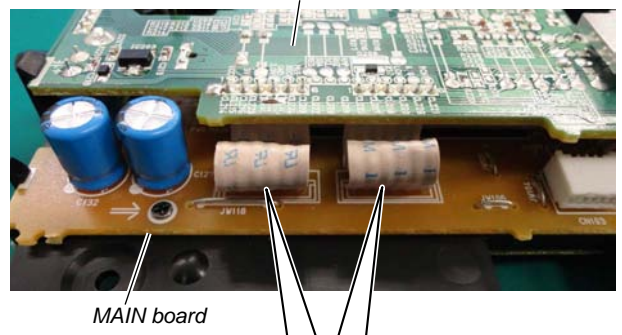
– Front bottom view –

2-6. JACK BOARD

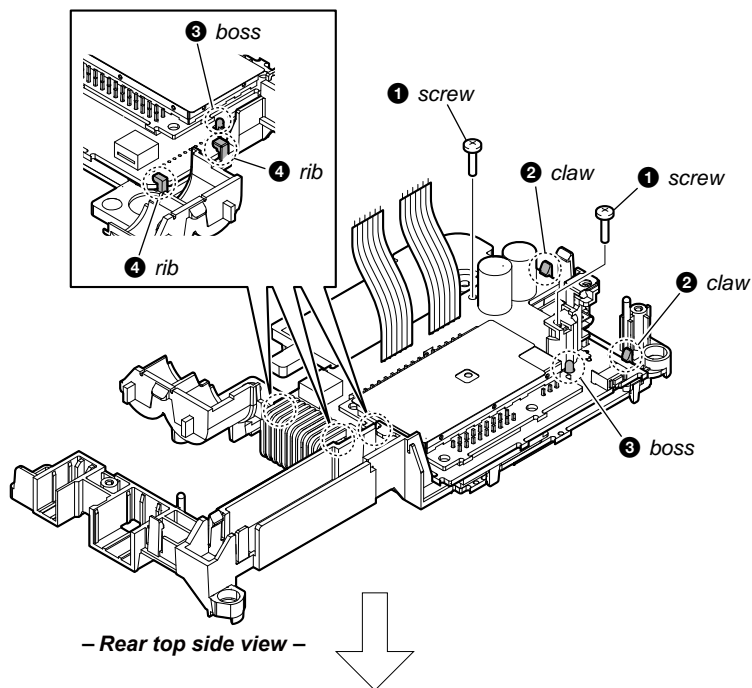


Note 2: When installing the JACK board, lean C216 and C230 in the direction of an arrow.

• Wire setting



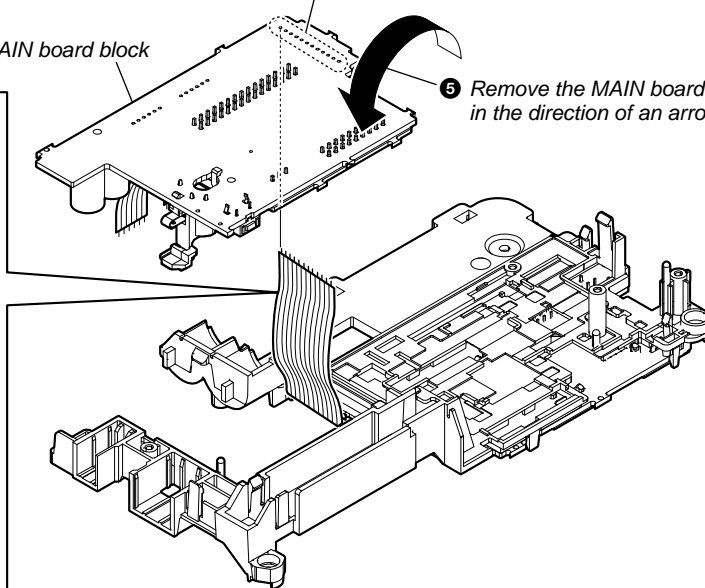
2-7. MAIN BOARD BLOCK



⑥ Remove twelve solders.

⑦ MAIN board block

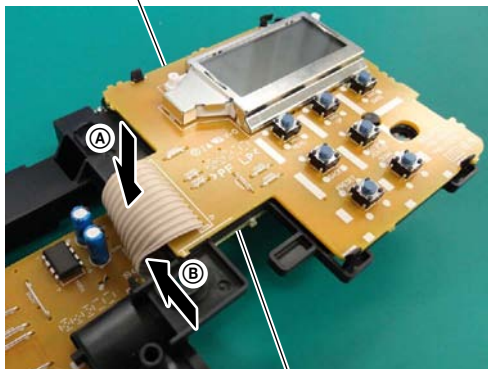
⑤ Remove the MAIN board block in the direction of an arrow.



• Wire setting

Note: Arrange a wire in order of arrow ① and arrow ②.

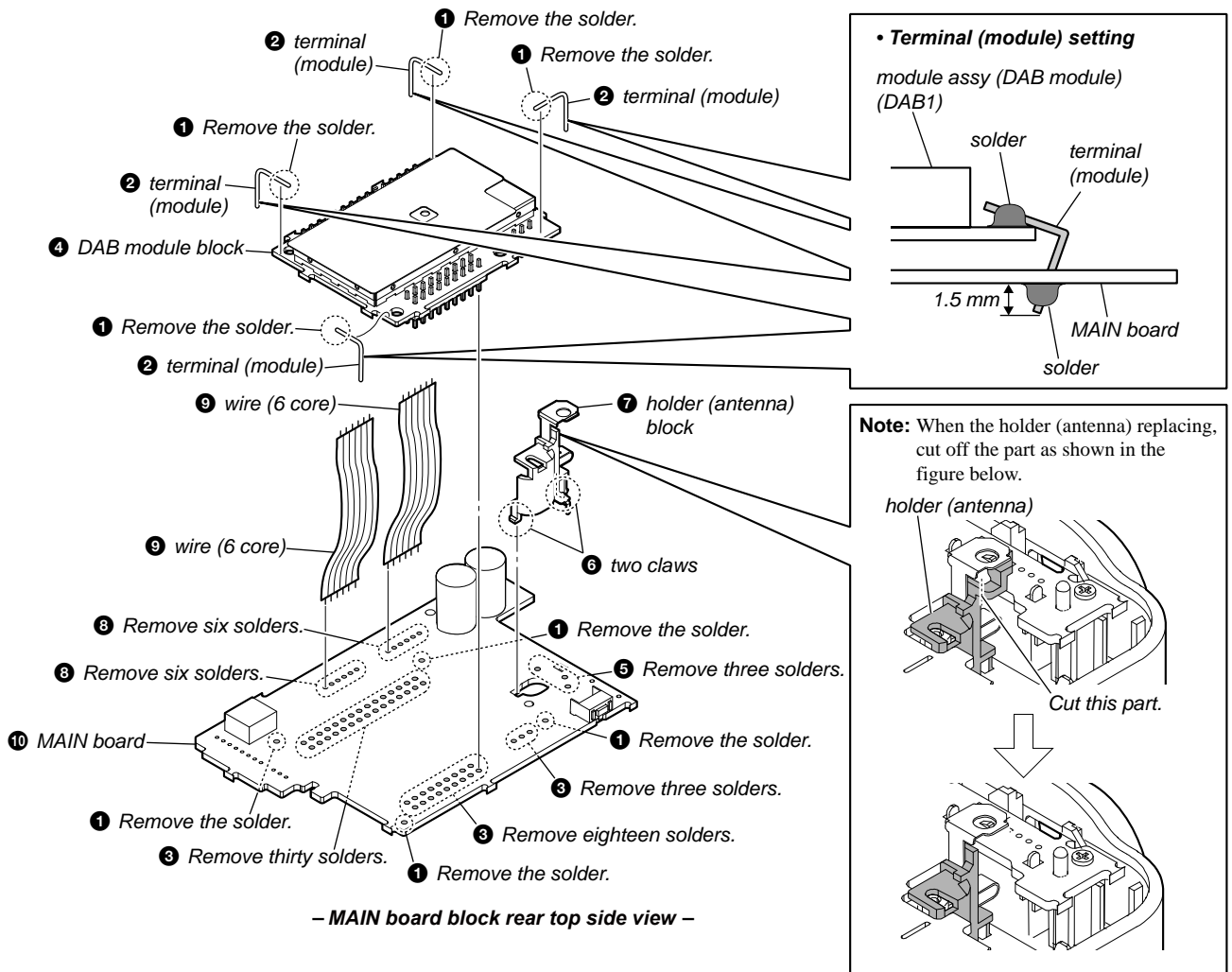
LCDDAB board



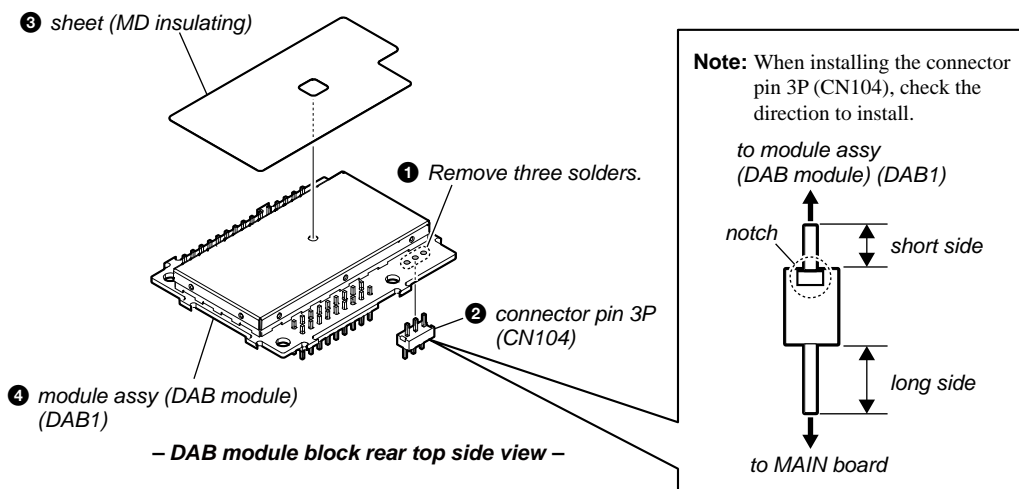
MAIN board

– Front bottom side view –

2-8. MAIN BOARD



2-9. MODULE ASSY (DAB MODULE) (DAB1)



SECTION 3 TEST MODE

1. PREPARATION OF TEST MODE

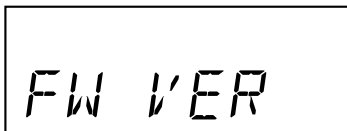
Prepare the following before checking test mode.

- AC adaptor
- Regulated DC power supply
- Dry battery 4PCS. (SIZE "AA", IEC designation LR6)
- Dummy battery
- Headphone
- Signal generator
- Oscilloscope
- Loop antenna
- Ammeter

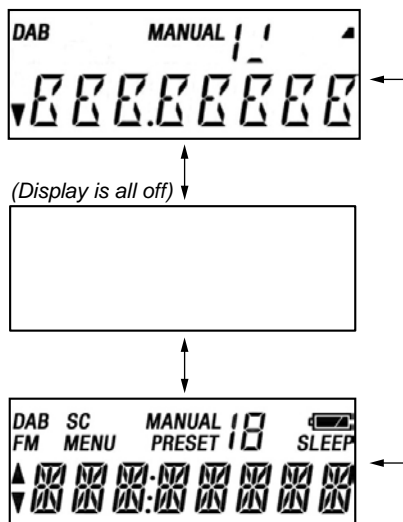
2. LCD CHECK

Procedure:

1. AC adaptor is inserted in DC jack (J201).
2. Press the [I/⏻] button to turn the power on.
3. Press the [DAB/FM] button, and checks that there is no "🔋" mark in the upper right of the liquid crystal display.
4. Press and hold the [I/⏻] button, while pressing the [MENU] button.
5. Release the [MENU] button ([I/⏻] button is holding).
6. Press the [▲], [▼] button in order, and release the [I/⏻] button. Enter the test mode and the "FW VER" appears.



7. Press the [▲] or [▼] buttons, select the "LCD CHK", and press the [ENTER/DISP] button.
8. The back light is turned on, and press the [▲] or [▼] buttons to change the display pattern. (Displayed characters/values in the following figure are example)



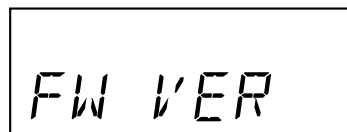
It checks that there are not contrast inconsistency and defective indication.

9. Pull out the AC adaptor.

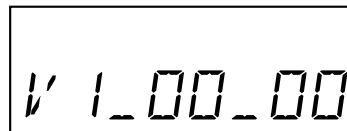
3. VERSION, RTC AND CURRENT CONSUMPTION CHECK

Procedure:

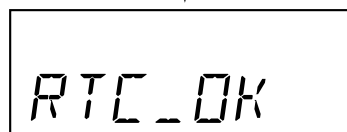
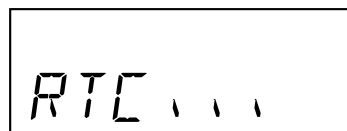
1. Dummy battery is set to the unit, and it connects with a regulated DC power supply, and outputs the voltage of 6V.
2. Telescopic antenna is set, and press the [I/⏻] button to turn the power on. Checks that there is "🔋" mark in the upper right of the liquid crystal display.
3. Press and hold the [I/⏻] button, while pressing the [MENU] button.
4. Release the [MENU] button ([I/⏻] button is holding).
5. Press the [▲], [▼] button in order, and release the [I/⏻] button. Enter the test mode and the "FW VER" appears.



6. Press the [ENTER/DISP] button to display the firmware version. (Displayed characters/values in the following figure are example)




7. Press the [BACK] button, return to the test menu.
8. Press the [▲] or [▼] buttons, select the "RTC CHK", and press the [ENTER/DISP] button to start the RTC check. The message "RTC_OK" appears on the liquid crystal display. Press the [BACK] button, return to the test menu.



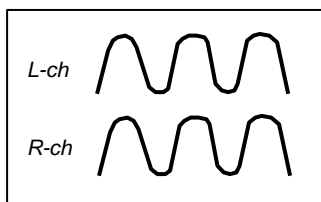
9. Press the [▲] or [▼] buttons, select the "INIT", and press the [ENTER/DISP] button twice to turn the power off.
10. Press the [I/⏻] button to turn the power on.
11. Press the [DAB/FM] button, change to DAB function. Checks that current consumption is under 150 mA using an ammeter.
12. Press the [DAB/FM] button, change to FM function. Checks that current consumption is under 160 mA using an ammeter.
13. Press the [I/⏻] button to turn the power off. Checks that current consumption is under 30 μA using an ammeter.
14. Remove dummy battery.

4. FM RECEPTION CHECK

Procedure:

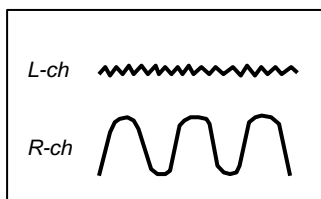
1. Input the following signal from signal generator to FM antenna input.
 Output frequency: 87.5 MHz
 Deviation: 75 kHz/M+S 27 %
 Modulation: 1 kHz
 Output level: 80 dBuV/m
2. L and R channels are outputted from the signal generator.
3. AC adaptor is inserted in DC jack (J201).
4. Press the [I/⏻] button to turn the power on.
5. Checks that there is no “” mark in the upper right of the liquid crystal display.
6. Press the [DAB/FM] button, change to FM function.
7. Press the [▲] or [▼] buttons, change to the frequency of “87.5 MHz”.
8. [- VOL +] jog is turned to center, headphone is inserted in headphone jack (J202) and it checks that the sound is outputted from headphone.
 It checks that there is no defect. Monaural, reception cannot be carried out and sensitivity is weak, etc.
9. [- VOL +] jog is turned in the counterclockwise direction to a minimum. The sound from a headphone becomes small suitably, and it checks that there is no defective sound quality.
 (Sound is not outputted at the time of a minimum)
10. [- VOL +] jog is turned in the clockwise direction to a maximum. The sound from a headphone becomes large suitably, and it checks that there is no defective sound quality.
11. Headphone is pull out from the unit. It checks that the unit is struck 3 times lightly and the sound from a speaker does not have interruption and defective sound quality.
12. [- VOL +] jog is turned in the counterclockwise direction to a minimum. The sound from a speaker becomes small suitably, and it checks that there is no defective sound quality.
 (Sound is not outputted at the time of a minimum)
13. [- VOL +] jog is turned in the clockwise direction to a maximum. The sound from a speaker becomes large suitably, and it checks that there is no defective sound quality.
14. The audio connecting cord from an oscilloscope is inserted in the headphone jack (J202).
15. The stereo waveforms are checked with an oscilloscope.

Example:



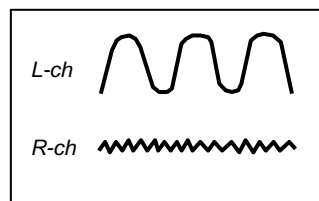
16. R channel is outputted from the signal generator, and R-channel waveform is checked with an oscilloscope.

Example:



17. L channel is outputted from the signal generator, and L-channel waveform is checked with an oscilloscope.

Example:



18. The audio connecting cord from an oscilloscope is pull out the headphone jack (J202).
19. Press the [I/⏻] button to turn the power off.
20. Pull out the AC adaptor.

5. DAB RECEPTION CHECK

Procedure:

1. Input the following signal from signal generator to DAB antenna input.
Output frequency: 174.928 MHz -48 dB/m
2. Equip this unit with dry battery.
3. Telescopic antenna is perpendicularly set to the unit.
4. Press the [I/⏻] button to turn the power on.
5. Press the [DAB/FM] button, and [- VOL +] jog is turned to center.
6. Press and hold the [I/⏻] button, while pressing the [MENU] button.
7. Release the [MENU] button ([I/⏻] button is holding).
8. Press the [▲], [▼] button in order, and release the [I/⏻] button. Enter the test mode and the "FW VER" appears.

A rectangular box containing the text "FW VER" in a digital, seven-segment font.

9. Press the [▼] button 3 times to select the "DAB CHK".

A rectangular box containing the text "DAB CHK" in a digital, seven-segment font.

10. L and R channels are outputted from the signal generator.
Press the [ENTER/DISP] button, the message "174_928M" appears on the liquid crystal display. Press the [ENTER/DISP] button again, the display will change to "CER_".

A rectangular box containing the text "174_928M" in a digital, seven-segment font.



A rectangular box containing the text "CER_" in a digital, seven-segment font.

11. Headphone is inserted in headphone jack (J202) and it checks that the sound is outputted from headphone.
It checks that there is no defect. Reception cannot be carried out and sensitivity is weak, etc.
12. [- VOL +] jog is turned in the counterclockwise direction to a minimum. The sound from a headphone becomes small suitably, and it checks that there is no defective sound quality.
(Sound is not outputted at the time of a minimum)
13. [- VOL +] jog is turned in the clockwise direction to a maximum. The sound from a headphone becomes large suitably, and it checks that there is no defective sound quality.
14. Headphone is pull out from the unit. It checks that the unit is struck 3 times lightly and the sound from a speaker does not have interruption and defective sound quality.
15. [- VOL +] jog is turned in the counterclockwise direction to a minimum. The sound from a speaker becomes small suitably, and it checks that there is no defective sound quality.
(Sound is not outputted at the time of a minimum)
16. [- VOL +] jog is turned in the clockwise direction to a maximum. The sound from a speaker becomes large suitably, and it checks that there is no defective sound quality.
17. Remove battery.

6. INITIALIZE

After the completion of repair, execute initialization.
All the settings, presets and the list of receivable DAB stations will be deleted.

Procedure:

1. Press the [I/⏻] button to turn the power on.
2. Press the [MENU] button, and the enter the menu mode.
3. Press the [▲] or [▼] buttons, select the "RESET", and press the [ENTER/DISP] button.
4. Press the [▲] or [▼] buttons, select the "OK", and press the [ENTER/DISP] button.
5. The message "COMPLETE" appears on the liquid crystal display, initialization is completed, then turn the power off.

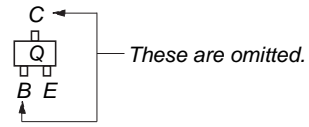
SECTION 4 DIAGRAMS

THIS NOTE IS COMMON FOR PRINTED WIRING BOARDS AND SCHEMATIC DIAGRAMS.
(In addition to this, the necessary note is printed in each block.)

For Printed Wiring Boards.

Note:

- : Parts extracted from the component side.
- : Parts extracted from the conductor side.
- : Pattern from the side which enables seeing. (The other layers' patterns are not indicated.)
- : Indication of transistor.



For Schematic Diagrams.

Note:

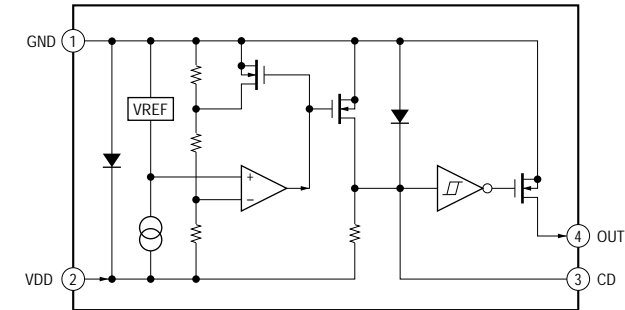
- All capacitors are in μF unless otherwise noted. (p: pF) 50 WV or less are not indicated except for electrolytics and tantalums.
- All resistors are in Ω and 1/4 W or less unless otherwise specified.
- : Panel designation.

Note: The components identified by mark Δ or dotted line with mark Δ are critical for safety. Replace only with part number specified.

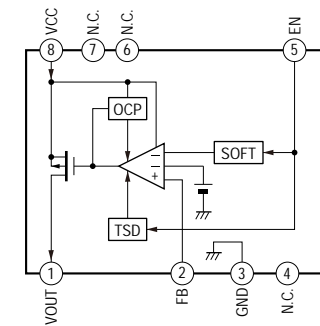
- : B+ Line.
- Voltages are dc with respect to ground under no-signal (detuned) conditions. no mark: TUNER (FM)
- Voltages are taken with VOM (Input impedance 10 M Ω). Voltage variations may be noted due to normal production tolerances.
- Signal path.
- ⇒: AUDIO

• IC Block Diagrams

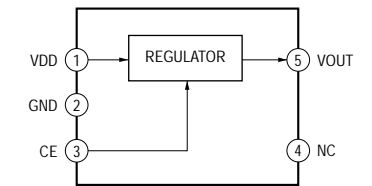
– MAIN Board – IC102 PST8436UL



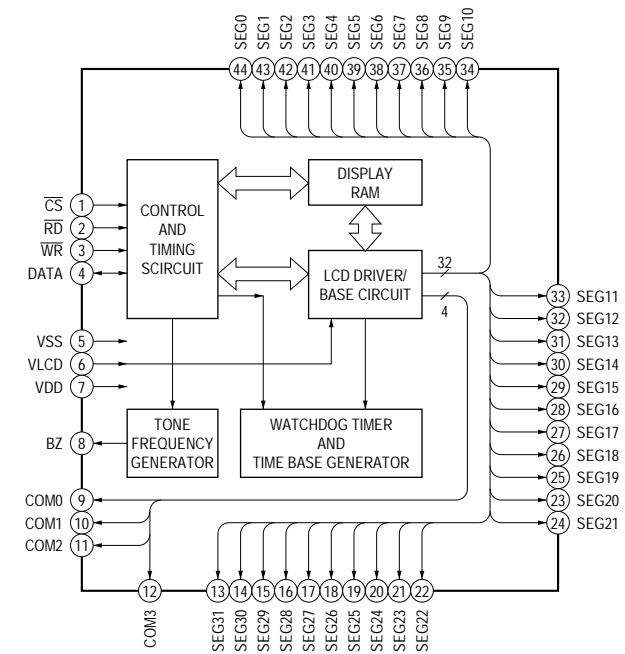
IC103 BD00GA5WEFJ-E2



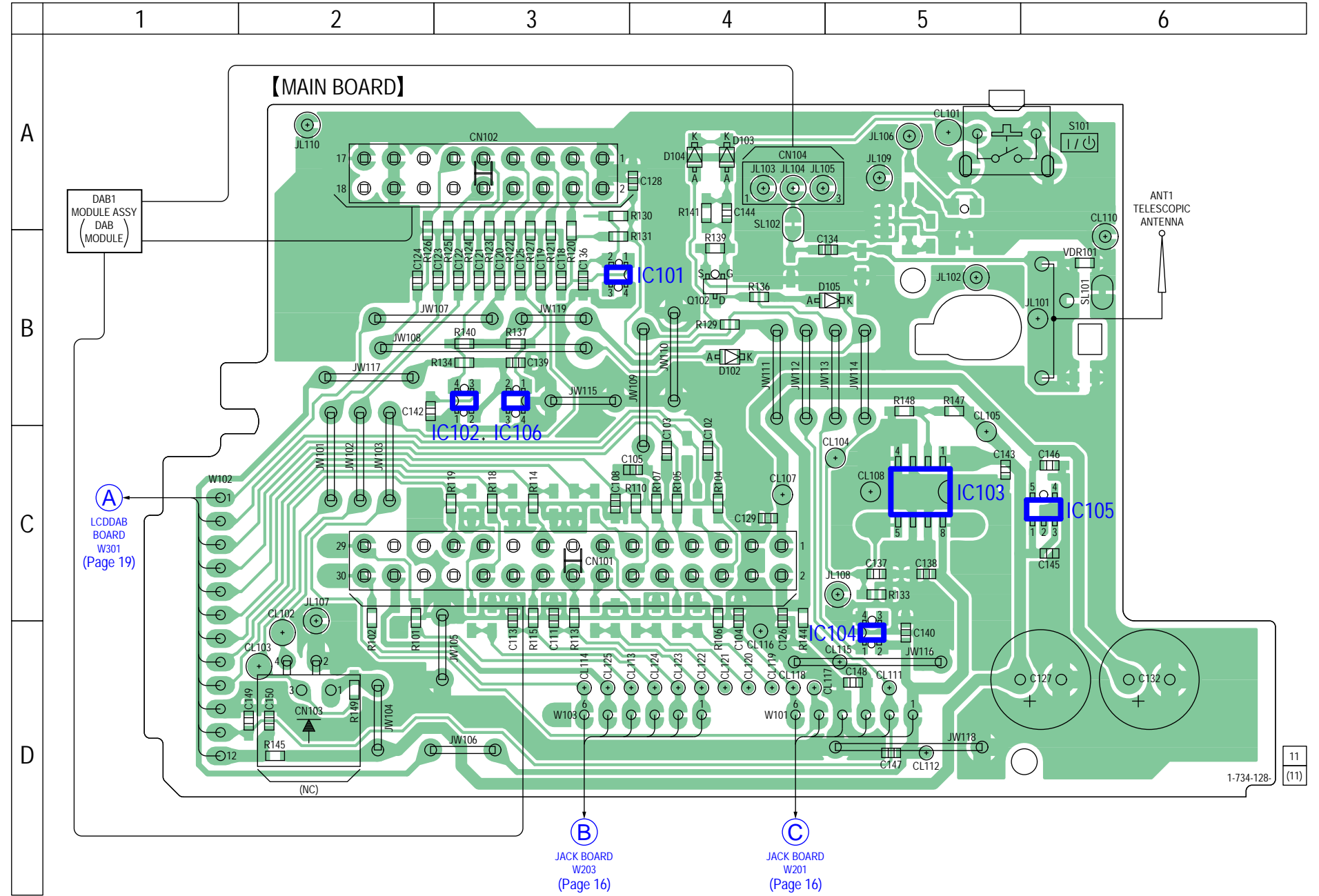
IC105 MM3291CNRE



– LCD Board – IC301 HT1621

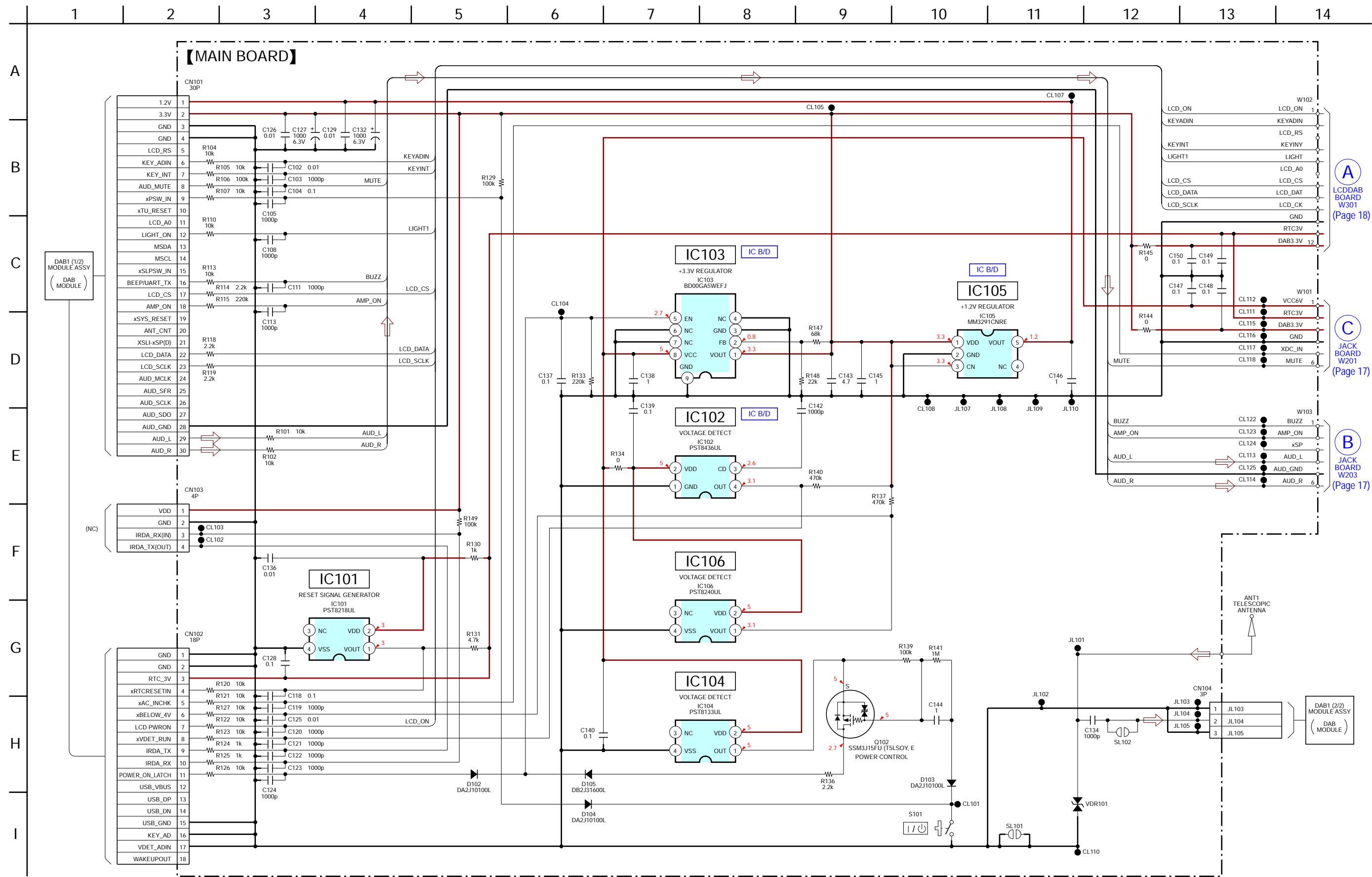


4-1. PRINTED WIRING BOARD - MAIN Board -  : Uses unleaded solder.

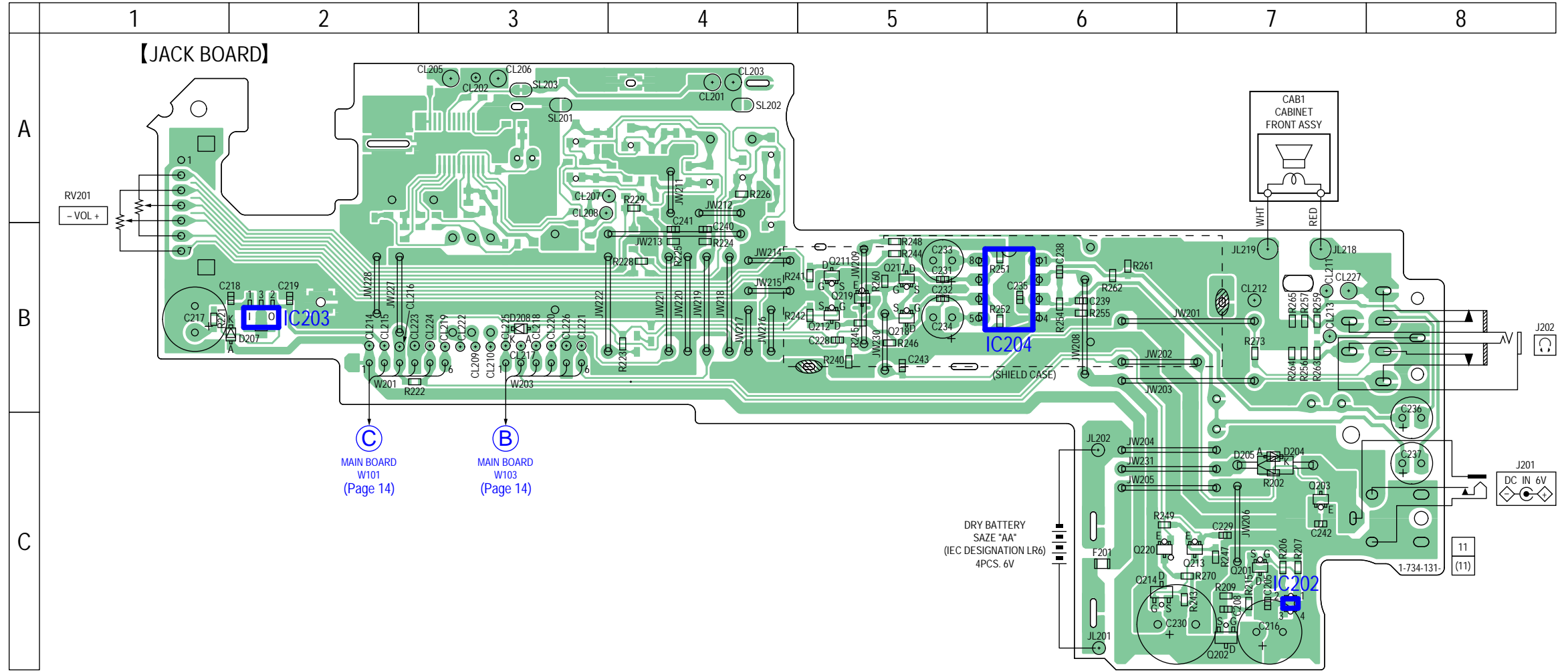


1-734-128-11 (11)

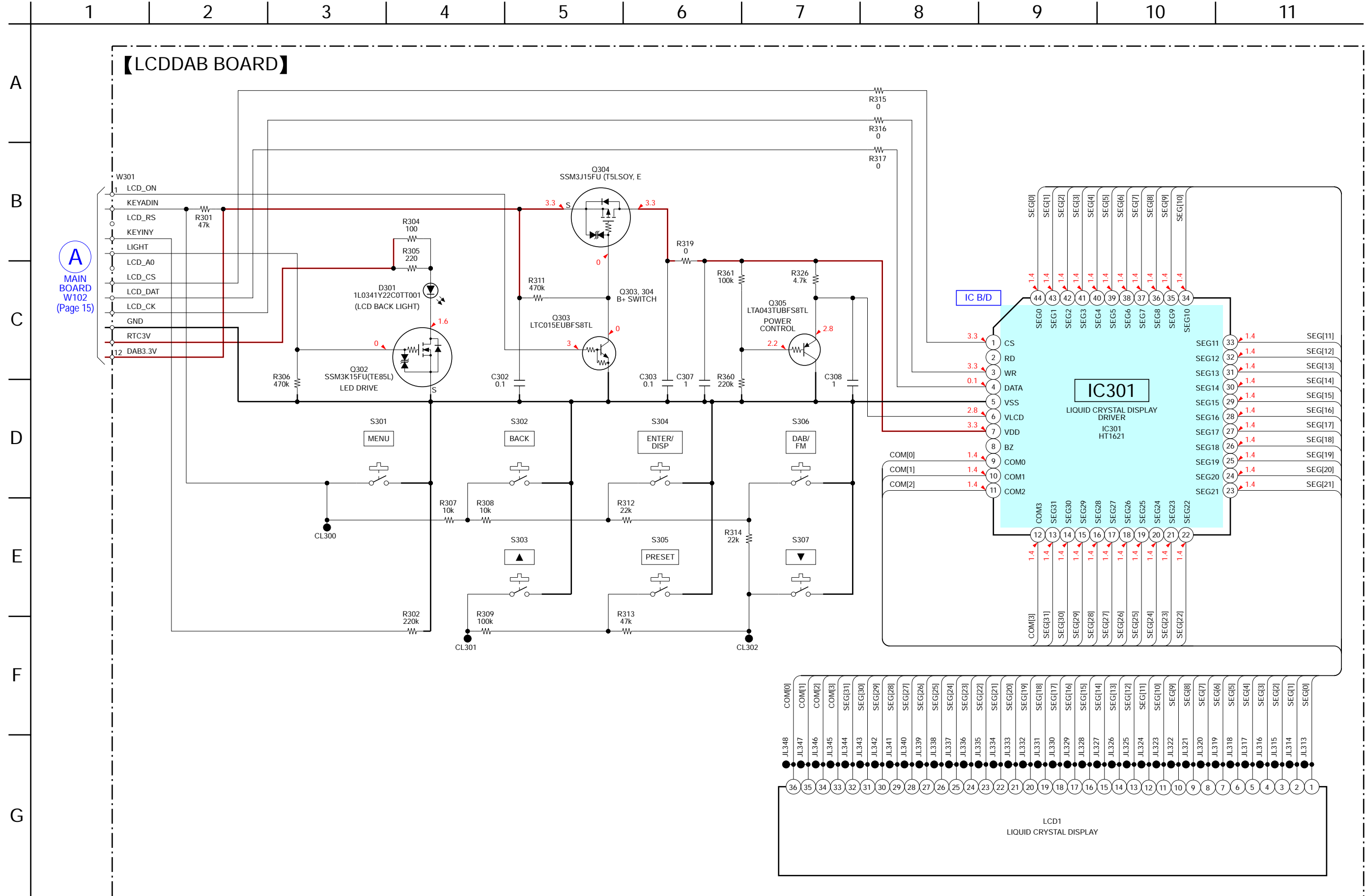
4-2. SCHEMATIC DIAGRAM - MAIN Board - • See page 13 for IC Block Diagrams.



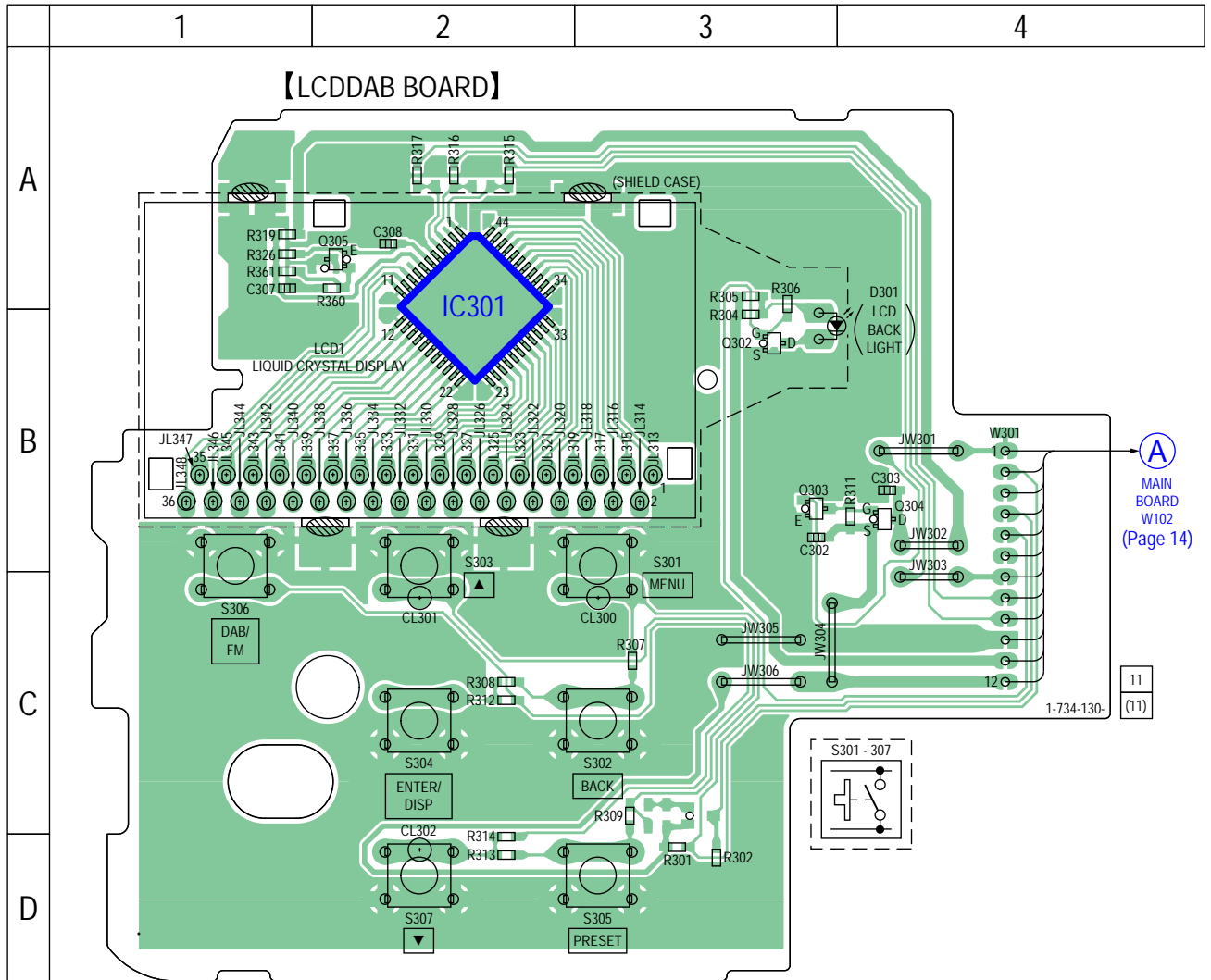
4-3. PRINTED WIRING BOARD - JACK Board -  : Uses unleaded solder.



4-5. SCHEMATIC DIAGRAM - LCDDAB Board - • See page 13 for IC Block Diagrams.



4-6. PRINTED WIRING BOARD - LCDDAB Board -  : Uses unleaded solder.



SECTION 5 EXPLODED VIEWS

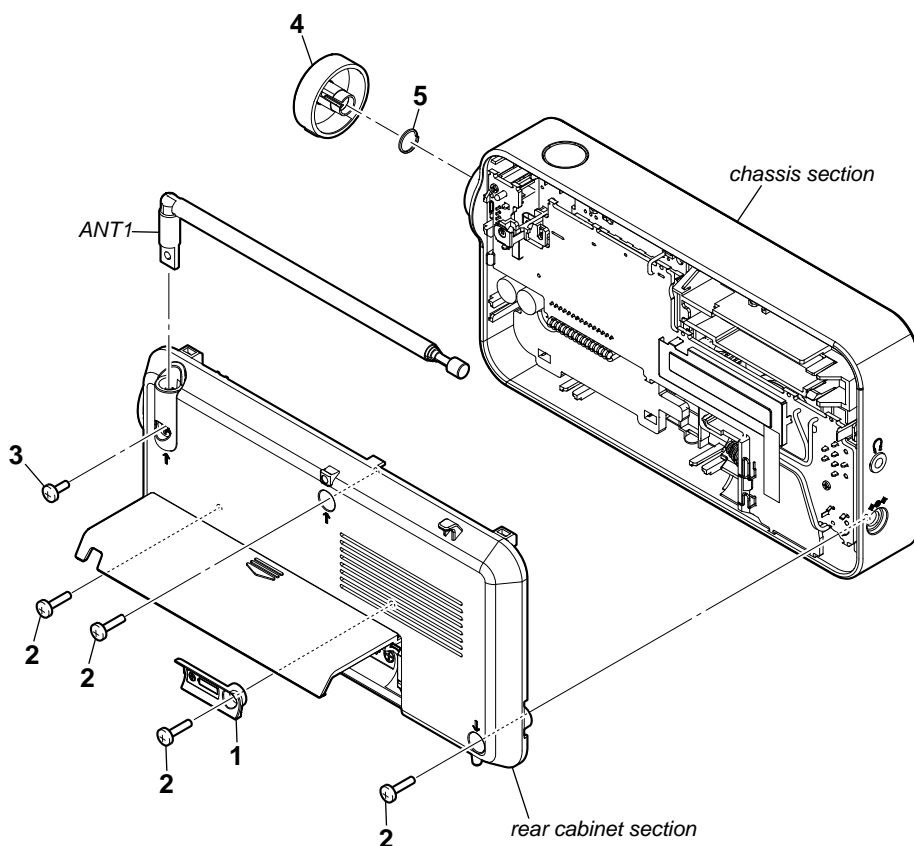
Note:

- -XX and -X mean standardized parts, so they may have some difference from the original one.
- Items marked “*” are not stocked since they are seldom required for routine service. Some delay should be anticipated when ordering these items.
- The mechanical parts with no reference number in the exploded views are not supplied.

- Color Indication of Appearance Parts Example:
 KNOB, BALANCE (WHITE) . . . (RED)
 ↑ ↑
 Parts Color Cabinet's Color

5-1. OVERALL SECTION

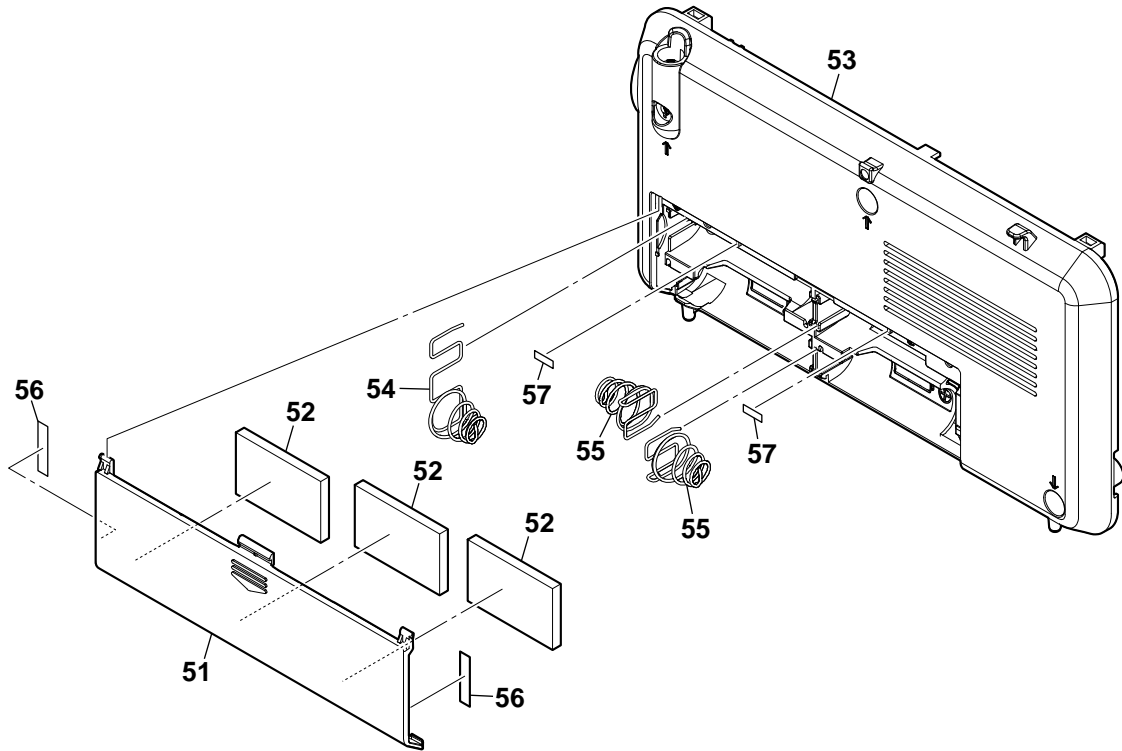
- Rear side view



Ref. No.	Part No.	Description	Remark	Ref. No.	Part No.	Description	Remark
1	4-437-698-01	LID, CONNECTOR		4	4-437-697-11	KNOB, VOL (for BLACK)	
2	3-252-827-01	SCREW (B2.6), (+) BV TAPPING (for WHITE, RED)		4	4-437-697-21	KNOB, VOL (for WHITE)	
2	3-252-827-11	SCREW (B2.6), (+) BV TAPPING (for BLACK)		4	4-437-697-31	KNOB, VOL (for RED)	
3	3-918-696-11	SCREW (M3X6 LOCK ACE) (for WHITE, RED)		5	4-461-252-01	SPRING, RING	
3	3-918-696-31	SCREW (M3X6 LOCK ACE) (for BLACK)		ANT1	1-754-856-21	ANTENNA, TELESCOPIC	

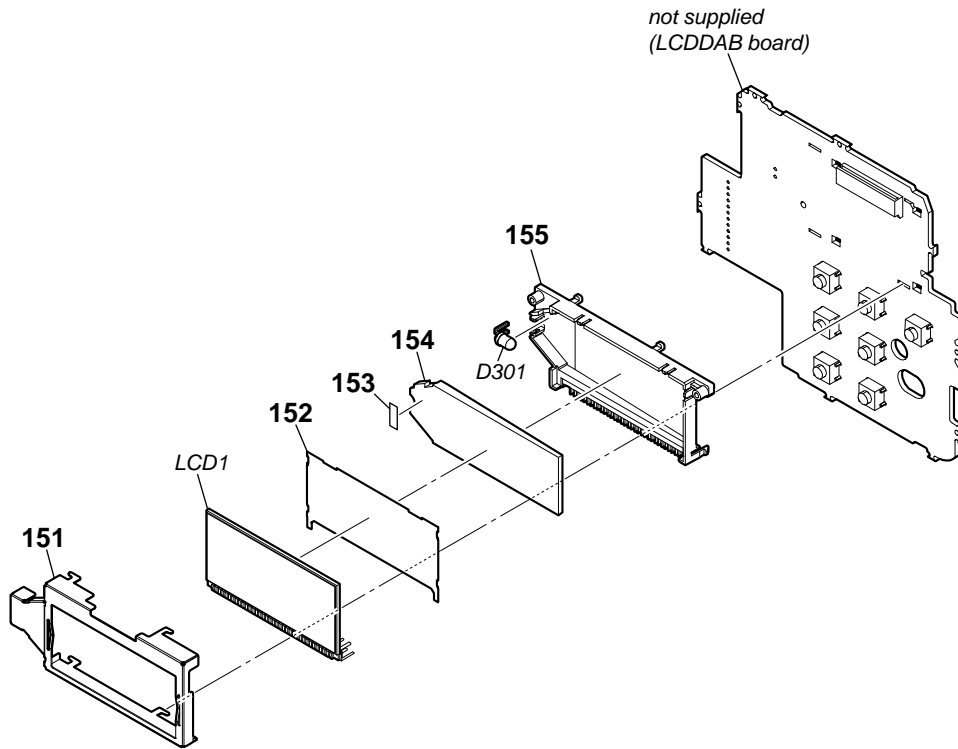
5-2. REAR CABINET SECTION

- Rear side view



Ref. No.	Part No.	Description	Remark	Ref. No.	Part No.	Description	Remark
51	4-437-686-04	LID, BATTERY CASE (for BLACK)		56	4-459-425-01	CUSHION (BATTERY CASE LID A) (for BLACK)	
51	4-437-686-24	LID, BATTERY CASE (for WHITE, RED)		56	4-459-425-11	CUSHION (BATTERY CASE LID A) (for WHITE, RED)	
52	3-267-201-01	CUSHION (BATTERY CASE LID)		57	4-459-426-01	CUSHION (BATTERY CASE LID B) (for BLACK)	
53	4-437-685-01	CABINET, REAR (for BLACK)		57	4-459-426-11	CUSHION (BATTERY CASE LID B) (for WHITE, RED)	
53	4-437-685-21	CABINET, REAR (for WHITE, RED)					
54	4-142-819-01	BATTERY TERMINAL + - (B)					
55	4-142-818-01	BATTERY TERMINAL + - (A)					

5-4. LCDDAB BOARD SECTION



<u>Ref. No.</u>	<u>Part No.</u>	<u>Description</u>	<u>Remark</u>	<u>Ref. No.</u>	<u>Part No.</u>	<u>Description</u>	<u>Remark</u>
151	4-437-728-01	CASE (LCD, DAB), SHIELD		155	4-437-691-01	LCD HOLDER (DAB)	
152	4-437-733-01	SHEET, DIFFUSION		D301	6-501-601-01	LED 1L0341Y22C0TT001 (LCD BACK LIGHT)	
153	4-450-048-01	CUSHION (LIGHT GUIDE PLATE)		LCD1	1-811-737-11	DISPLAY PANEL, LIQUID CRYSTAL	
154	4-437-692-01	PLATE, LIGHT GUIDE					

SECTION 6
ELECTRICAL PARTS LIST

Note:

- Due to standardization, replacements in the parts list may be different from the parts specified in the diagrams or the components used on the set.
- -XX and -X mean standardized parts, so they may have some difference from the original one.
- Items marked "*" are not stocked since they are seldom required for routine service. Some delay should be anticipated when ordering these items.
- RESISTORS
All resistors are in ohms.
METAL: Metal-film resistor.
METAL OXIDE: Metal oxide-film resistor.
F: nonflammable

- CAPACITORS
uF: μ F
- COILS
uH: μ H
- SEMICONDUCTORS
In each case, u: μ , for example:
uA. . . : μ A. . . , uPA. . . , μ PA. . . ,
uPB. . . : μ PB. . . , uPC. . . , μ PC. . . ,
uPD. . . : μ PD. . .

When indicating parts by reference number, please include the board name.

The components identified by mark Δ or dotted line with mark Δ are critical for safety.
Replace only with part number specified.

Ref. No.	Part No.	Description	Remark	Ref. No.	Part No.	Description	Remark
		JACK BOARD *****				< TRANSISTOR >	
		< CAPACITOR >		Q201	6-550-742-01	FET SSM3K15FU (TE85L)	
C205	1-162-970-11	CERAMIC CHIP 0.01uF	10% 25V	Q202	6-552-262-01	FET SSM3J305T (T5LSOY, E)	
C208	1-107-826-11	CERAMIC CHIP 0.1uF	10% 16V	Q203	6-552-433-01	TRANSISTOR DRC5115E0L	
C216	1-126-935-11	ELECT 470uF	20% 16V	Q211	6-550-742-01	FET SSM3K15FU (TE85L)	
C217	1-126-916-11	ELECT 1000uF	20% 6.3V	Q212	6-550-742-01	FET SSM3K15FU (TE85L)	
C218	1-112-298-91	CERAMIC CHIP 1uF	10% 16V	Q213	8-729-905-37	TRANSISTOR 2SC4081T106Q	
C219	1-165-908-11	CERAMIC CHIP 1uF	10% 10V	Q214	6-552-262-01	FET SSM3J305T (T5LSOY, E)	
C228	1-162-970-11	CERAMIC CHIP 0.01uF	10% 25V	Q217	6-550-742-01	FET SSM3K15FU (TE85L)	
C229	1-112-746-11	CERAMIC CHIP 4.7uF	10% 6.3V	Q218	6-550-742-01	FET SSM3K15FU (TE85L)	
C230	1-126-926-11	ELECT 1000uF	20% 10V	Q219	6-552-433-01	TRANSISTOR DRC5115E0L	
C231	1-165-908-11	CERAMIC CHIP 1uF	10% 10V	Q220	8-729-905-37	TRANSISTOR 2SC4081T106Q	
C232	1-165-908-11	CERAMIC CHIP 1uF	10% 10V			< RESISTOR >	
C233	1-104-665-11	ELECT 100uF	20% 25V	R202	1-216-833-11	METAL CHIP 10K 5% 1/10W	
C234	1-104-665-11	ELECT 100uF	20% 25V	R206	1-216-821-11	METAL CHIP 1K 5% 1/10W	
C235	1-112-298-91	CERAMIC CHIP 1uF	10% 16V	R207	1-216-853-11	METAL CHIP 470K 5% 1/10W	
C236	1-126-934-11	ELECT 220uF	20% 16V	R209	1-216-853-11	METAL CHIP 470K 5% 1/10W	
C237	1-126-934-11	ELECT 220uF	20% 16V	R215	1-216-845-11	METAL CHIP 100K 5% 1/10W	
C238	1-107-826-11	CERAMIC CHIP 0.1uF	10% 16V	R221	1-216-821-11	METAL CHIP 1K 5% 1/10W	
C239	1-107-826-11	CERAMIC CHIP 0.1uF	10% 16V	R222	1-216-853-11	METAL CHIP 470K 5% 1/10W	
C240	1-162-970-11	CERAMIC CHIP 0.01uF	10% 25V	R223	1-216-833-11	METAL CHIP 10K 5% 1/10W	
C241	1-162-970-11	CERAMIC CHIP 0.01uF	10% 25V	R224	1-216-825-11	METAL CHIP 2.2K 5% 1/10W	
C242	1-107-826-11	CERAMIC CHIP 0.1uF	10% 16V	R225	1-216-825-11	METAL CHIP 2.2K 5% 1/10W	
C243	1-107-826-11	CERAMIC CHIP 0.1uF	10% 16V	R226	1-216-853-11	METAL CHIP 470K 5% 1/10W	
		< DIODE >		R228	1-216-864-11	SHORT CHIP 0	
D204	6-502-961-01	DIODE DA2J10100L		R229	1-216-864-11	SHORT CHIP 0	
D205	8-719-063-79	DIODE 1N4002B		R240	1-216-817-11	METAL CHIP 470 5% 1/10W	
D207	6-503-716-01	DIODE DB2J31600L		R241	1-216-833-11	METAL CHIP 10K 5% 1/10W	
D208	6-502-961-01	DIODE DA2J10100L		R242	1-216-833-11	METAL CHIP 10K 5% 1/10W	
		< FUSE >		R243	1-216-853-11	METAL CHIP 470K 5% 1/10W	
Δ F201	1-523-132-31	FUSE (1 A/50 V)		R244	1-216-821-11	METAL CHIP 1K 5% 1/10W	
		< IC >		R245	1-216-821-11	METAL CHIP 1K 5% 1/10W	
IC202	6-715-431-01	IC PST8225UL		R246	1-216-845-11	METAL CHIP 100K 5% 1/10W	
IC203	6-707-748-01	IC XC6201P302PR		R247	1-216-845-11	METAL CHIP 100K 5% 1/10W	
IC204	8-759-502-21	IC TDA2822M		R248	1-216-845-11	METAL CHIP 100K 5% 1/10W	
		< JACK >		R249	1-216-853-11	METAL CHIP 470K 5% 1/10W	
J201	1-580-681-21	JACK, DC (POLARITY UNIFIED TYPE)	(DC IN 6V \diamond \diamond)	R251	1-216-833-11	METAL CHIP 10K 5% 1/10W	
J202	1-785-448-21	JACK (\odot)		R252	1-216-833-11	METAL CHIP 10K 5% 1/10W	
				R254	1-216-793-11	METAL CHIP 4.7 5% 1/10W	
				R255	1-216-793-11	METAL CHIP 4.7 5% 1/10W	
				R256	1-216-813-11	METAL CHIP 220 5% 1/10W	
				R257	1-216-813-11	METAL CHIP 220 5% 1/10W	
				R259	1-216-813-11	METAL CHIP 220 5% 1/10W	

Ref. No.	Part No.	Description	Remark	Ref. No.	Part No.	Description	Remark
R260	1-216-853-11	METAL CHIP 470K 5%	1/10W	R360	1-216-849-11	METAL CHIP 220K 5%	1/10W
R261	1-216-833-11	METAL CHIP 10K 5%	1/10W	R361	1-216-845-11	METAL CHIP 100K 5%	1/10W
R262	1-216-833-11	METAL CHIP 10K 5%	1/10W			< SWITCH >	
R263	1-216-813-11	METAL CHIP 220 5%	1/10W	S301	1-554-937-11	SWITCH, KEY BOARD (MENU)	
R264	1-216-803-11	METAL CHIP 33 5%	1/10W	S302	1-554-937-11	SWITCH, KEY BOARD (BACK)	
R265	1-216-803-11	METAL CHIP 33 5%	1/10W	S303	1-554-937-11	SWITCH, KEY BOARD (▲)	
R270	1-216-821-11	METAL CHIP 1K 5%	1/10W	S304	1-554-937-11	SWITCH, KEY BOARD (ENTER/DISP)	
R273	1-216-833-11	METAL CHIP 10K 5%	1/10W	S305	1-554-937-11	SWITCH, KEY BOARD (PRESET)	
		< VARIABLE RESISTOR >		S306	1-554-937-11	SWITCH, KEY BOARD (DAB/FM)	
RV201	1-227-774-21	RES, VAR, CARBON 20K/20K (- VOL +)		S307	1-554-937-11	SWITCH, KEY BOARD (▼)	
*****				*****			
		LCDDAB BOARD				MAIN BOARD	
		*****				*****	
	4-437-691-01	LCD HOLDER (DAB)		4-437-730-01	TERMINAL, ANT		
	4-437-692-01	PLATE, LIGHT GUIDE		4-439-771-01	HOLDER (ANTENNA)		
	4-437-728-01	CASE (LCD, DAB), SHIELD		4-441-303-01	SHEET (INSULATING, MD)		
	4-437-733-01	SHEET, DIFFUSION		4-455-484-01	TERMINAL (MODULE)		
	4-450-048-01	CUSHION (LIGHT GUIDE PLATE)				< CAPACITOR >	
		< CAPACITOR >		C102	1-162-970-11	CERAMIC CHIP 0.01uF 10%	25V
C302	1-107-826-11	CERAMIC CHIP 0.1uF 10%	16V	C103	1-162-964-11	CERAMIC CHIP 0.001uF 10%	50V
C303	1-107-826-11	CERAMIC CHIP 0.1uF 10%	16V	C104	1-107-826-11	CERAMIC CHIP 0.1uF 10%	16V
C307	1-165-908-11	CERAMIC CHIP 1uF 10%	10V	C105	1-162-964-11	CERAMIC CHIP 0.001uF 10%	50V
C308	1-165-908-11	CERAMIC CHIP 1uF 10%	10V	C108	1-162-964-11	CERAMIC CHIP 0.001uF 10%	50V
		< LED >		C111	1-162-964-11	CERAMIC CHIP 0.001uF 10%	50V
D301	6-501-601-01	LED 1L0341Y22C0TT001 (LCD BACK LIGHT)		C113	1-162-964-11	CERAMIC CHIP 0.001uF 10%	50V
		< IC >		C118	1-107-826-11	CERAMIC CHIP 0.1uF 10%	16V
IC301	6-715-273-01	IC HT1621		C119	1-162-964-11	CERAMIC CHIP 0.001uF 10%	50V
		< LIQUID CRYSTAL DISPLAY >		C120	1-162-964-11	CERAMIC CHIP 0.001uF 10%	50V
LCD1	1-811-737-11	DISPLAY PANEL, LIQUID CRYSTAL		C121	1-162-964-11	CERAMIC CHIP 0.001uF 10%	50V
		< TRANSISTOR >		C122	1-162-964-11	CERAMIC CHIP 0.001uF 10%	50V
Q302	6-550-742-01	FET SSM3K15FU (TE85L)		C123	1-162-964-11	CERAMIC CHIP 0.001uF 10%	50V
Q303	6-552-433-01	TRANSISTOR DRC5115E0L		C124	1-162-964-11	CERAMIC CHIP 0.001uF 10%	50V
Q304	6-552-237-01	FET SSM3J15FU (T5LSOY, E		C125	1-162-970-11	CERAMIC CHIP 0.01uF 10%	25V
Q305	6-552-931-01	TRANSISTOR LTA043TUBFS8TL		C126	1-162-970-11	CERAMIC CHIP 0.01uF 10%	25V
		< RESISTOR >		C127	1-126-916-11	ELECT 1000uF 20%	6.3V
R301	1-216-841-11	METAL CHIP 47K 5%	1/10W	C128	1-107-826-11	CERAMIC CHIP 0.1uF 10%	16V
R302	1-216-849-11	METAL CHIP 220K 5%	1/10W	C129	1-162-970-11	CERAMIC CHIP 0.01uF 10%	25V
R304	1-216-809-11	METAL CHIP 100 5%	1/10W	C132	1-126-916-11	ELECT 1000uF 20%	6.3V
R305	1-216-813-11	METAL CHIP 220 5%	1/10W	C134	1-162-964-11	CERAMIC CHIP 0.001uF 10%	50V
R306	1-216-853-11	METAL CHIP 470K 5%	1/10W	C136	1-162-970-11	CERAMIC CHIP 0.01uF 10%	25V
R307	1-216-833-11	METAL CHIP 10K 5%	1/10W	C137	1-107-826-11	CERAMIC CHIP 0.1uF 10%	16V
R308	1-216-833-11	METAL CHIP 10K 5%	1/10W	C138	1-112-298-91	CERAMIC CHIP 1uF 10%	16V
R309	1-216-845-11	METAL CHIP 100K 5%	1/10W	C139	1-107-826-11	CERAMIC CHIP 0.1uF 10%	16V
R311	1-216-853-11	METAL CHIP 470K 5%	1/10W	C140	1-107-826-11	CERAMIC CHIP 0.1uF 10%	16V
R312	1-216-837-11	METAL CHIP 22K 5%	1/10W	C142	1-162-964-11	CERAMIC CHIP 0.001uF 10%	50V
R313	1-216-841-11	METAL CHIP 47K 5%	1/10W	C143	1-112-746-11	CERAMIC CHIP 4.7uF 10%	6.3V
R314	1-216-837-11	METAL CHIP 22K 5%	1/10W	C144	1-165-908-11	CERAMIC CHIP 1uF 10%	10V
R315	1-216-864-11	SHORT CHIP 0		C145	1-165-908-11	CERAMIC CHIP 1uF 10%	10V
R316	1-216-864-11	SHORT CHIP 0		C146	1-165-908-11	CERAMIC CHIP 1uF 10%	10V
R317	1-216-864-11	SHORT CHIP 0		C147	1-107-826-11	CERAMIC CHIP 0.1uF 10%	16V
R319	1-216-864-11	SHORT CHIP 0		C148	1-107-826-11	CERAMIC CHIP 0.1uF 10%	16V
R326	1-216-829-11	METAL CHIP 4.7K 5%	1/10W	C149	1-107-826-11	CERAMIC CHIP 0.1uF 10%	16V
				C150	1-107-826-11	CERAMIC CHIP 0.1uF 10%	16V
						< CONNECTOR >	
				CN103	1-784-726-11	CONNECTOR, FFC 4P	
				CN104	1-843-530-11	PIN, CONNECTOR 3P	

XDR-S40DBP

MAIN

Ref. No.	Part No.	Description	Remark
		< DIODE >	
D102	6-502-961-01	DIODE DA2J10100L	
D103	6-502-961-01	DIODE DA2J10100L	
D104	6-502-961-01	DIODE DA2J10100L	
D105	6-503-716-01	DIODE DB2J31600L	
		< IC >	
IC101	6-715-607-01	IC PST8218UL	
IC102	6-715-665-01	IC PST8436UL	
IC103	6-717-441-01	IC BD00GA5WEFJ-E2	
IC104	6-719-917-01	IC PST8133UL	
IC105	6-711-132-01	IC MM3291CNRE	
IC106	6-715-620-01	IC PST8240UL	
		< TRANSISTOR >	
Q102	6-552-237-01	FET SSM3J15FU (T5LSOY, E)	
		< RESISTOR >	
R101	1-216-833-11	METAL CHIP 10K 5%	1/10W
R102	1-216-833-11	METAL CHIP 10K 5%	1/10W
R104	1-216-833-11	METAL CHIP 10K 5%	1/10W
R105	1-216-833-11	METAL CHIP 10K 5%	1/10W
R106	1-216-845-11	METAL CHIP 100K 5%	1/10W
R107	1-216-833-11	METAL CHIP 10K 5%	1/10W
R110	1-216-833-11	METAL CHIP 10K 5%	1/10W
R113	1-216-833-11	METAL CHIP 10K 5%	1/10W
R114	1-216-825-11	METAL CHIP 2.2K 5%	1/10W
R115	1-216-849-11	METAL CHIP 220K 5%	1/10W
R118	1-216-825-11	METAL CHIP 2.2K 5%	1/10W
R119	1-216-825-11	METAL CHIP 2.2K 5%	1/10W
R120	1-216-833-11	METAL CHIP 10K 5%	1/10W
R121	1-216-833-11	METAL CHIP 10K 5%	1/10W
R122	1-216-833-11	METAL CHIP 10K 5%	1/10W
R123	1-216-833-11	METAL CHIP 10K 5%	1/10W
R124	1-216-821-11	METAL CHIP 1K 5%	1/10W
R125	1-216-821-11	METAL CHIP 1K 5%	1/10W
R126	1-216-833-11	METAL CHIP 10K 5%	1/10W
R127	1-216-833-11	METAL CHIP 10K 5%	1/10W
R129	1-216-845-11	METAL CHIP 100K 5%	1/10W
R130	1-216-821-11	METAL CHIP 1K 5%	1/10W
R131	1-216-829-11	METAL CHIP 4.7K 5%	1/10W
R133	1-216-849-11	METAL CHIP 220K 5%	1/10W
R134	1-216-864-11	SHORT CHIP 0	
R136	1-216-825-11	METAL CHIP 2.2K 5%	1/10W
R137	1-216-853-11	METAL CHIP 470K 5%	1/10W
R139	1-216-845-11	METAL CHIP 100K 5%	1/10W
R140	1-216-853-11	METAL CHIP 470K 5%	1/10W
R141	1-216-857-11	METAL CHIP 1M 5%	1/10W
R144	1-216-864-11	SHORT CHIP 0	
R145	1-216-864-11	SHORT CHIP 0	
R147	1-250-660-11	METAL CHIP 68K 1%	1/10W
R148	1-250-648-11	METAL CHIP 22K 1%	1/10W
R149	1-216-845-11	METAL CHIP 100K 5%	1/10W
		< SWITCH >	
S101	1-798-464-11	SWITCH, TACTILE (I/⏏)	

Ref. No.	Part No.	Description	Remark
		< VARISTOR >	
VDR101	1-802-255-11	ESD SUPPRESSOR	

		MISCELLANEOUS	

ANT1	1-754-856-21	ANTENNA, TELESCOPIC	
CAB1	A-1904-051-A	CABINET FRONT ASSY (Including SPEAKER, BUTTON) (for BLACK)	
CAB1	A-1908-256-A	CABINET FRONT ASSY (Including SPEAKER, BUTTON) (for WHITE)	
CAB1	A-1908-260-A	CABINET FRONT ASSY (Including SPEAKER, BUTTON) (for RED)	
CN104	1-843-530-11	PIN, CONNECTOR 3P	
D301	6-501-601-01	LED 1L0341Y22C0TT001 (LCD BACK LIGHT)	
DAB1	X-2587-128-1	MODULE ASSY (SVX) (DAB module)	
J202	1-785-448-21	JACK (⊕)	
LCD1	1-811-737-11	DISPLAY PANEL, LIQUID CRYSTAL	

		ACCESSORIES	

△	1-491-975-51	ADAPTOR, AC (AC-P6005E) (Australian)	
△	1-491-975-61	ADAPTOR, AC (AC-P6005F) (AEP)	
△	1-491-975-81	ADAPTOR, AC (AC-P6005H) (UK)	
	4-449-401-11	MANUAL, INSTRUCTION (ENGLISH)	
	4-449-401-21	MANUAL, INSTRUCTION (SWEDISH, DANISH) (AEP)	
	4-449-401-31	MANUAL, INSTRUCTION (ITALIAN, FRENCH) (AEP)	
	4-449-401-41	MANUAL, INSTRUCTION (DUTCH, SPANISH) (AEP)	
	4-449-401-51	MANUAL, INSTRUCTION (GERMAN) (AEP)	

MEMO

